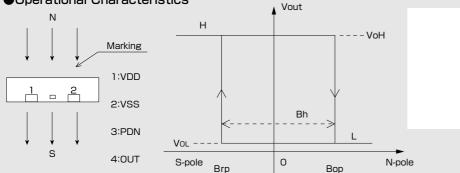


Shipped in packet-tape reel(5000pcs/Reel)

EM-0711 is ultra-small Hall effect ICs of a single silicon chip composed of Hall element and a signal processing IC.

Bipolar Hall	Supply Voltage	Power down	Ultra High Sensitivity	Output	SON
Effect Latch	1.6~5.5V	Function	Bop:1.8mT	CMOS	
Notice It is requested to	read and accept "IMPOF	TANT NOTICE" written	on the back of the front co	iver of this catalogu	2

Operational Characteristics





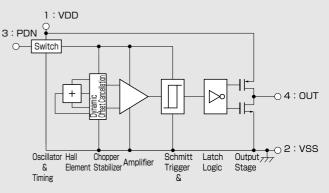
Magnetic flux density ●Absolute Maximum Ratings (Ta=25℃)

Item	Symbol	Limit	Unit	
Supply Voltage	VDD	$-0.1 \sim 6.0$	V	
PDN input voltage	V _{in}	-0.1 ~ VDD+0.1	V	
PDN input current	Iin	±10	mA	
Output Current	Iout	±0.5	mA	
Operating Temperature Range	Topr	$-30 \sim +85$	°C	
Storage Temperature Range	Tstg	$-40 \sim +125$	Ĵ	

●Magnetic ① and Electrical Characteristics (Ta=25°C VDD=3.0V)

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Supply Voltage	VDD		1.6		5.5	V
Operating Point	B _{OP}			1.8	4.0	mT
Release Point	Brp		-4.0	-1.8		mT
Hysteresis	Bh			3.6		mT
PDN input High voltage	VIH		0.7VDD			V
PDN input Low voltage	$V_{\rm IL}$				0.3	V
Output High Voltage	V _{он}	lo=-0.5mA	VDD —0.4			V
Output Low Voltage	V _{OL}	Io=+0.5mA			0.4	V
Supply Current 1*2	IDD1	PDN=L			1	μA
Supply Current2*2	IDD2	PDN=H,Average		2.5	6	mA
PDN input Current	Iin		-1		1	μA
PDN mode transition time1	T _{PD} 1	Active→PDN			100	μsec
PDN mode transition time2	T _{PD} 2	PDN→Active			100	μsec

Functional Block Diagram



Magnetic Characteristics ② (Ta=-30~+85°C VDD=3.0V)

Item	Symbol	Conditions	Min.	Тур.	Max.	Unit
Operating Point	B _{OP}			1.8	4.2	mT
Release Point	B _{rp}		-4.2	-1.8		mT
Hysteresis	Bh			3.6		mT

Note) The above specifications are design targets.

1 [mT] =10 [Gauss] *1: Positive("+") polarity flux is defined as the magnetic flux from south pole which is direct toward to the branded face of the sensor (Bop,Brp) *2: In case of PDN pin is held at VDD or VSS.

ASAHI KASEI MICRODEVICES

0

-40

-20

20

Ambient Temperature [°C]

0

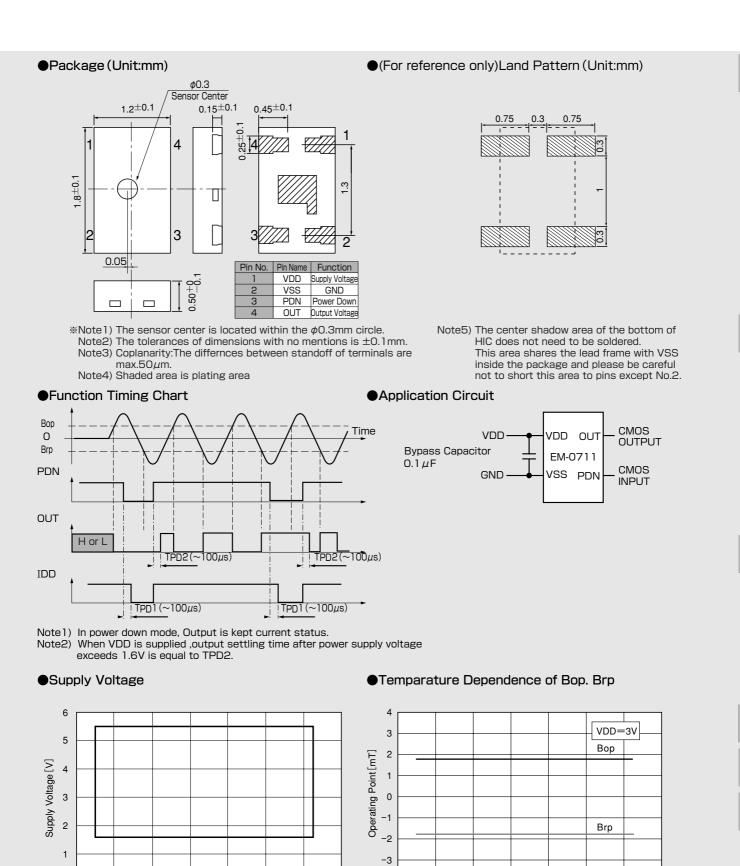
40

60

80

•Please be aware that our products are not intended for use in life support equipment, devices, or systems. Use of our products in such applications requires the advance written approval of our sales staff.

Certain applications using semiconductor devices may involve potential risks of personal injury, property damage, or loss of life. In order to minimize these risks, adequate design and operating safeguards should be provided by the customer to minimize inherent or procedural hazards. Inclusion of our products in such applications is understood to be fully at the risk of the customer using our devices or systems.



-4

-40

-20

0

20

Ambient Temperature [°C]

40

60

80

100

100

k

р

IMPORTANT NOTICE ·

- These products and their specifications are subject to change without notice. When you consider any use or application of these products, please make inquiries the sales office of Asahi Kasei Microdevices Corporation (AKM) or authorized distributors as to current status of the products.
- Descriptions of external circuits, application circuits, software and other related information contained in this document are provided only to illustrate the operation and application examples of the semiconductor products. You are fully responsible for the incorporation of these external circuits, application circuits, software and other related information in the design of your equipments. AKM assumes no responsibility for any losses incurred by you or third parties arising from the use of these information herein. AKM assumes no liability for infringement of any patent, intellectual property, or other rights in the application or use of such information contained herein.
- Any export of these products, or devices or systems containing them, may require an export license or other official approval under the law and regulations of the country of export pertaining to customs and tariffs, currency exchange, or strategic materials.
- AKM products are neither intended nor authorized for use as critical components_{Note1} in any safety, life support, or other hazard related device or system_{Note2}, and AKM assumes no responsibility for such use, except for the use approved with the express written consent by Representative Director of AKM. As used here:

Note1) A critical component is one whose failure to function or perform may reasonably be expected to result, whether directly or indirectly, in the loss of the safety or effectiveness of the device or system containing it, and which must therefore meet very high standards of performance and reliability.

Note2) A hazard related device or system is one designed or intended for life support or maintenance of safety or for applications in medicine, aerospace, nuclear energy, or other fields, in which its failure to function or perform may reasonably be expected to result in loss of life or in significant injury or damage to person or property.

It is the responsibility of the buyer or distributor of AKM products, who distributes, disposes of, or otherwise places the product with a third party, to notify such third party in advance of the above content and conditions, and the buyer or distributor agrees to assume any and all responsibility and liability for and hold AKM harmless from any and all claims arising from the use of said product in the absence of such notification.